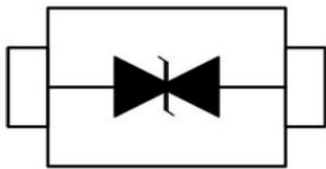




Pinout and Functional Block Diagram



Applications

- Series ATA
- USB2.0 Power and Data Line Protection
- Notebooks, Desktops, and Servers
- Cell Phone Handsets and Accessories
- Display Ports
- Digital Visual Interface (DVI)
- MDDI Ports

Description

The SD0505D52U is a low-capacitance Transient Voltage Suppressor (TVS) designed to provide electrostatic discharge (ESD) protection for high-speed data interfaces. With typical capacitance of 0.4 pF, SD0505D52U is designed to protect parasitic-sensitive systems against over-voltage and over-current transient events. It complies with IEC 61000-4-2 (ESD), Level 4 (± 15 kV air, ± 8 kV contact discharge), IEC 61000-4-4 (electrical fast transient - EFT) (40 A, 5 / 50 ns), very fast charged device model (CDM) ESD and cable discharge event (CDE), etc.

SD0505D52U uses ultra-small SOD-523 package. Each device can protect one high-speed data line. It offers system designers flexibility to protect single data line where space is a premium concern. The combined features of low capacitance, ultra-small size and high ESD robustness make SD0505D52U ideal for high-speed data port and high-frequency line (e.g., USB 2.0 & antenna line) applications, such as cellular phones and HD visual devices.

Features

- IEC61000-4-2 (ESD) ± 25 kV (Air), ± 20 kV (Contact)
- IEC61000-4-4 (EFT) 40 A (5 / 50 ns)
- Cable Discharge Event (CDE)
- Package Optimized for High Speed Line
- Ultra-small Package 1.6 mm \times 0.8 mm \times 0.6 mm
- Protects One Data, Control Line (Bidirectional)
- Low Capacitance 0.25 pF(Typical)
- Low Clamping Voltage
- Low Leakage Current
- High Temperature to Reflow Soldering Guaranteed: 260 $^{\circ}$ C / 10 sec
- Flammability Rating: UL 94 V-0
- Halogen Free and RoHS Compliant

Order Information

Type	Package	Marking Code	Delivery Form	Delivery Quantity
SD0505D52U	SOD523	5 G	7" T&R	3000 PCS

ESD Protection Diodes

Bidirectional ESD and Transient Voltage Protection

SD0505D52U SOD523

Limiting Values

($T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Symbol	Parameter	Conditions	Min	Max	Unit
V_{ESD}	Electrostatic Discharge Voltage	IEC 61000-4-2; Contact Discharge	-	20	kV
		IEC 61000-4-2; Air Discharge	-	25	kV
I_{PP}	Peak Pulse Current	$t_p=8 / 20\ \mu\text{s}$ per IEC61000-4-5		5	A
T_A	Operating Temperature Range	-	-55	125	$^\circ\text{C}$
T_{stg}	Storage Temperature Range	-	-55	150	$^\circ\text{C}$

Electrical Characteristics

($T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified)

Symbol	Parameter	Conditions	Min	Typ.	Max	Unit
V_{RWM}	Reverse Working Voltage	$T_A = 25\text{ }^\circ\text{C}$	-	-	5.0	V
V_{BR}	Breakdown Voltage	$I_R = 1\ \text{mA}; T_A = 25\text{ }^\circ\text{C}$	6.0	-	-	V
I_R	Reverse Leakage Current	$V_{RWM} = 5\ \text{V}; T_A = 25\text{ }^\circ\text{C}$	-	-	0.1	μA
V_C	Clamping Voltage	$I_{PP}=1\ \text{A}, t_p=8 / 20\ \mu\text{s}$	-	-	12	V
		$I_{PP}=5\ \text{A}, t_p=8 / 20\ \mu\text{s}$	-	-	28	V
C_J	Junction Capacitance	$V_R = 0\ \text{V}, f = 1\ \text{MHz}$	-	0.25	0.4	pF

ESD TVS

ESD TVS

Performance Curve for Reference

($T_A=25\text{ }^\circ\text{C}$ unless otherwise noted)

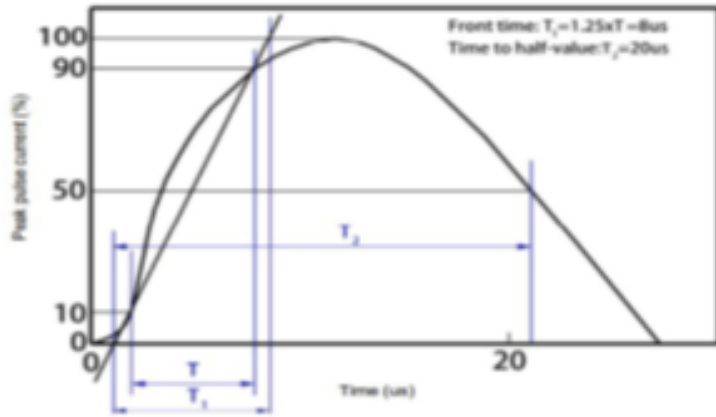


FIGURE 1

8 / 20 μs Waveform Per IEC61000-4-5

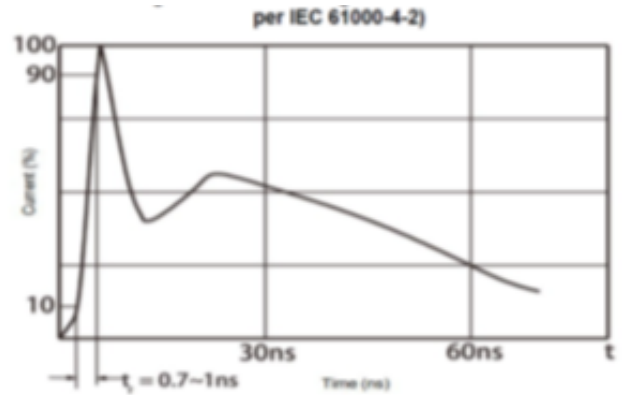


FIGURE 2

Contact Discharge Current Waveform Per IEC 61000-4-2

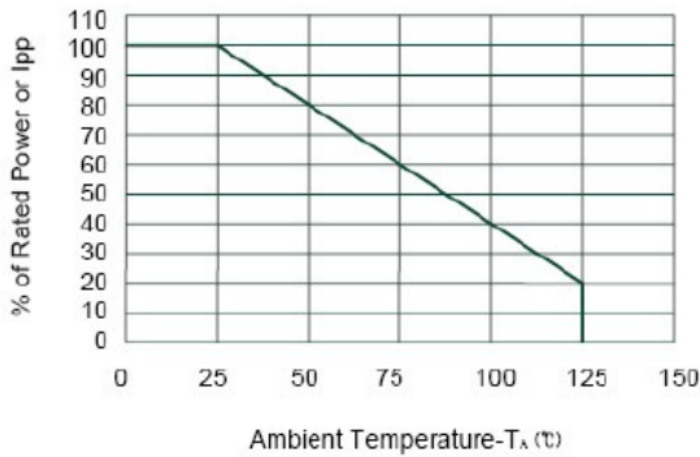


FIGURE 3

Power Derating Curve

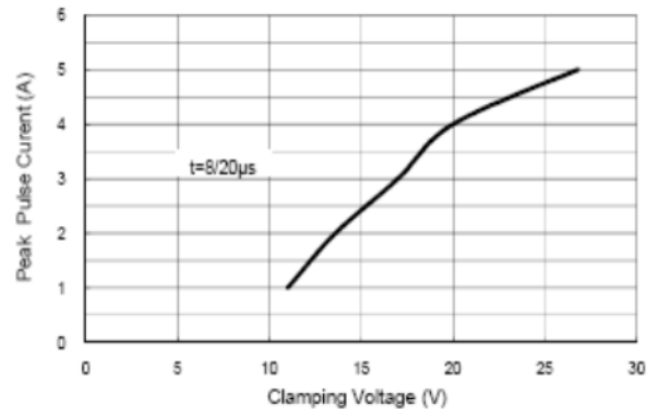


FIGURE 4

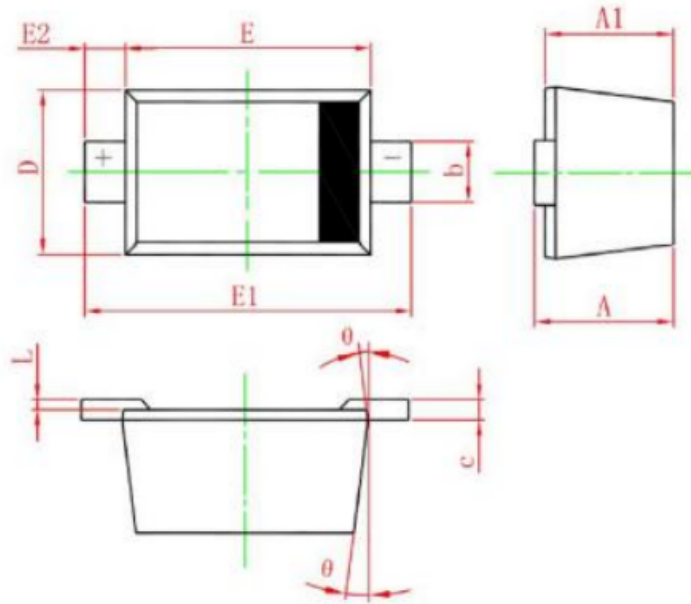
Clamping Voltage vs. Peak Pulse Current

ESD Protection Diodes

Bidirectional ESD and Transient Voltage Protection

SD0505D52U SOD523

Package Dimensions - SOD523

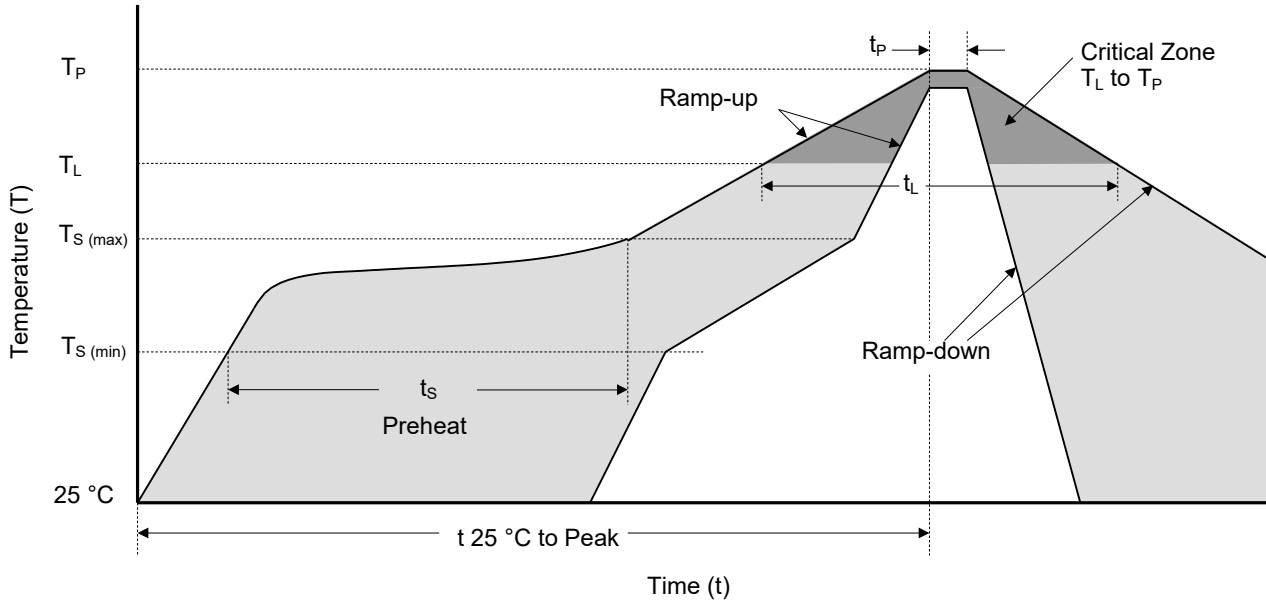


ESD TVS

ESD TVS

Symbol	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.51	0.77	0.020	0.031
A1	0.50	0.70	0.020	0.028
b	0.25	0.35	0.010	0.014
c	0.08	0.15	0.003	0.006
D	0.70	0.90	0.028	0.035
E	1.10	1.30	0.043	0.051
E1	1.50	1.70	0.059	0.067
E2	0.20 REF		0.008 REF	
L	0.01	0.07	0.001	0.003
φ	7 ° REF		7 ° REF	

Soldering Parameters



Reflowing Condition

Reflow Soldering Parameters		Lead-Free Assembly
Pre-heat	Temperature Min ($T_{S (min)}$)	150 °C
	Temperature Max ($T_{S (max)}$)	200 °C
	Time (min to max) (t_s)	60 ~ 120 seconds
Average Ramp Up Rate (Liquidus Temp (T_L) to Peak)		3 °C / second max.
$T_S (max)$ to T_L Ramp-up Rate		3 °C / second max.
Reflow	Temperature (T_L) (Liquidus)	217 °C
	Time (min to max) (t_L)	60 ~ 150 seconds
Peak Temperature (T_P)		260 ^{+0/-5} °C
Time of within 5 °C of Actual Peak Temperature (t_p)		20 ~ 40 seconds
Ramp-down Rate		6 °C / second max.
Time from 25 °C to Peak Temperature		8 Minutes max.
Do Not Exceed		260 °C

ESD TVS

ESD TVS



ATTENTION

Usage

1. TVS must be operated in the specified ambient temp.
2. Do not clean the TVS with strong polar solvent such as ketone, esters, benzene and halogenated hydrocarbon, to avoid damaging the encapsulating layer.
3. Please do not apply severe vibration, shock or pressure to TVS, to avoid element cracking.

Replacement

1. If TVS is visually damaged, please replace it.
2. TVS is a non-repairable product. For safety sake, please use equivalent TVS for replacement.

Storage

1. Storage Temp. Range: (-55 to 150) °C.
2. Do not store the TVS at the high temp., high humidity or corrosive gas environment, to avoid influencing the solder- ability of the lead wires. The product shall be used up within 1 year after receiving the goods.

Environmental Conditions

1. TVS should not be exposed to the open air, nor direct sunshine.
2. TVS should avoid rain, water vapor or other condition of high temp. and high humidity.
3. TVS should avoid sand dust, salt mist, or other harmful gases.

Max. Typical Capacitance of TVS

1. The typical capacitance of TVS is listed in the specifications. Designers may refer to it when designing TVS in High frequency circuit.

Installation Mechanical Stress

1. Do not knock TVS when installing, to avoid mechanical damage.
2. Please do not apply severe vibration, shock or pressure to TVS, to avoid surface resin or element cracking.